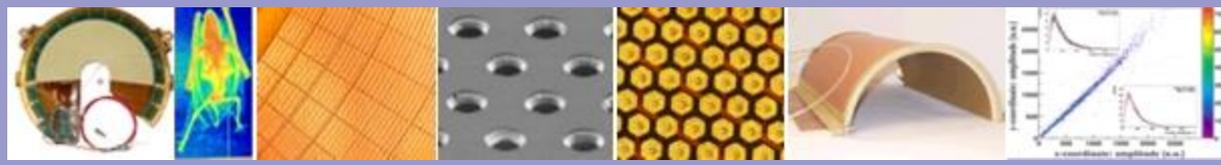




CERN

European Organization for Nuclear Research  
Organisation Européenne pour la Recherche Nucléaire

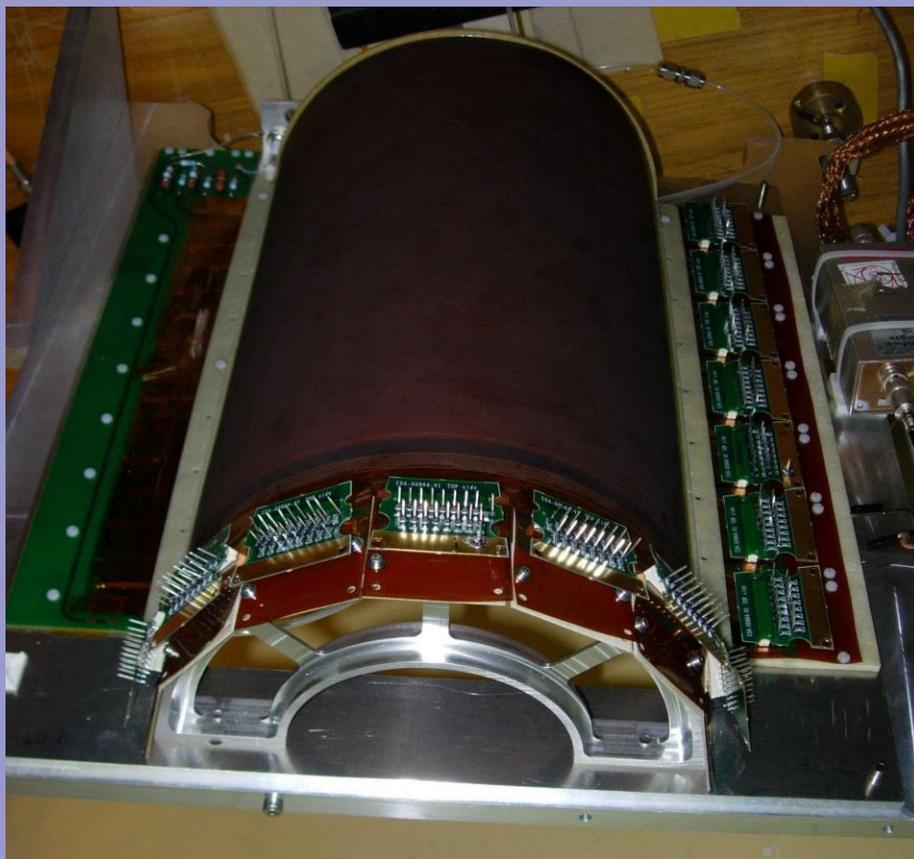
# Gas Electron Multiplier Radiation Detector for the Future Invented and Produced at CERN



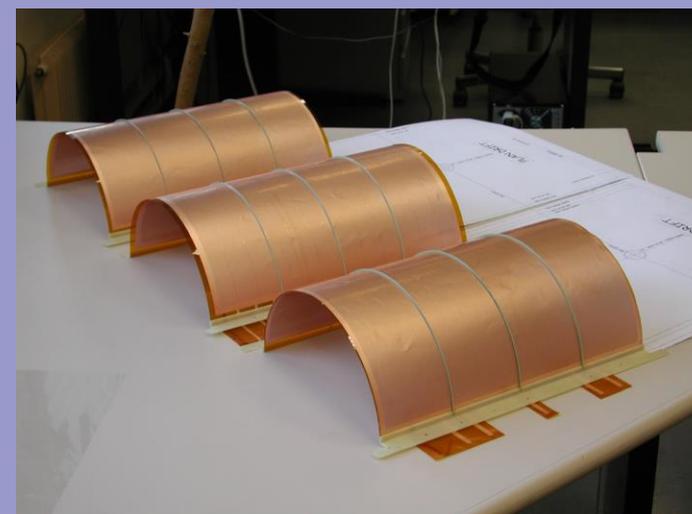
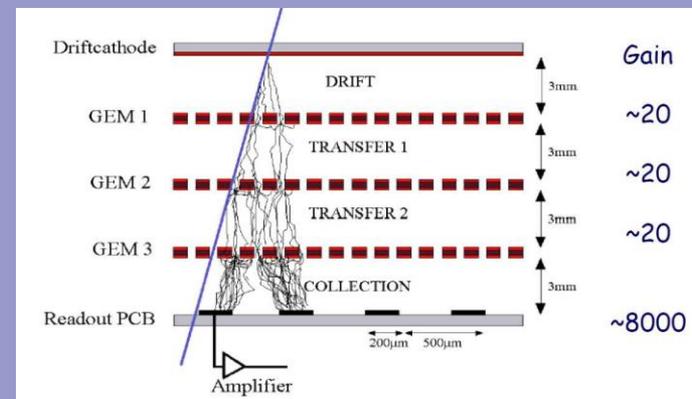
CERN

# GEM Detector

Gas Electron Multiplier Detector consists of drift electrode, 3 GEM foils and readout electrode.



Semi-cylindrical GEM detector



3 GEM foils before being mounted into detector

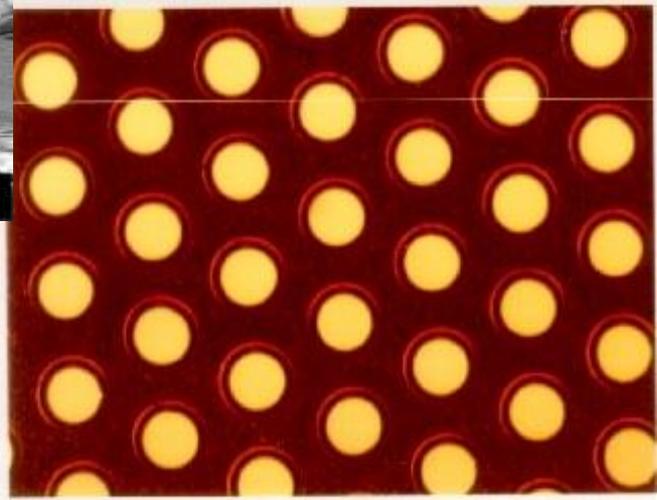
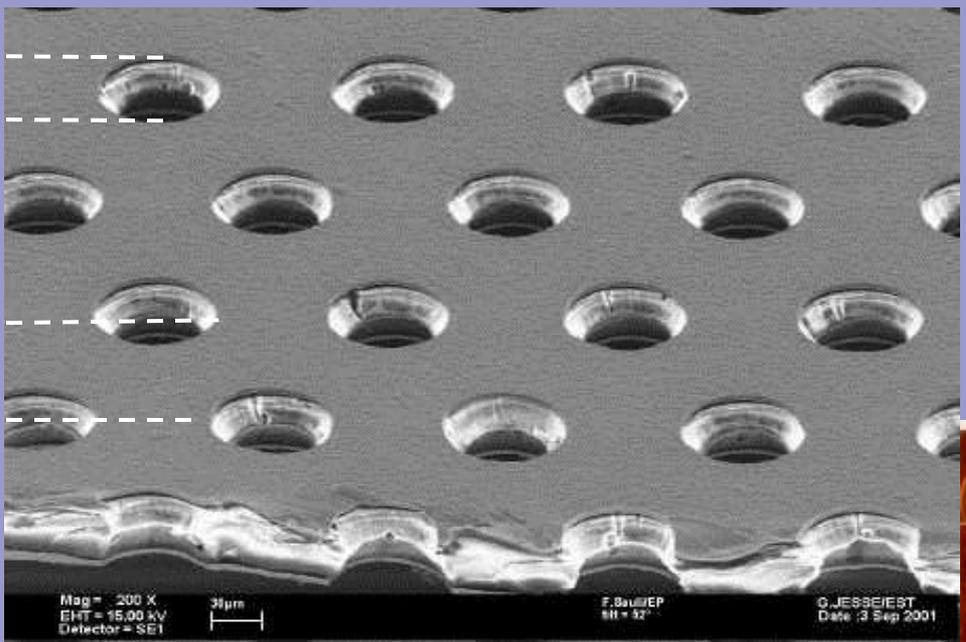


# GEM Foil

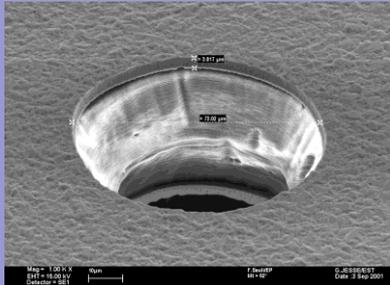
GEM foil – copper clad polyimide film, 50  $\mu\text{m}$  thick, pierced with millions of tiny holes. Each hole diameter corresponds to the width of the human hair.

70  $\mu\text{m}$

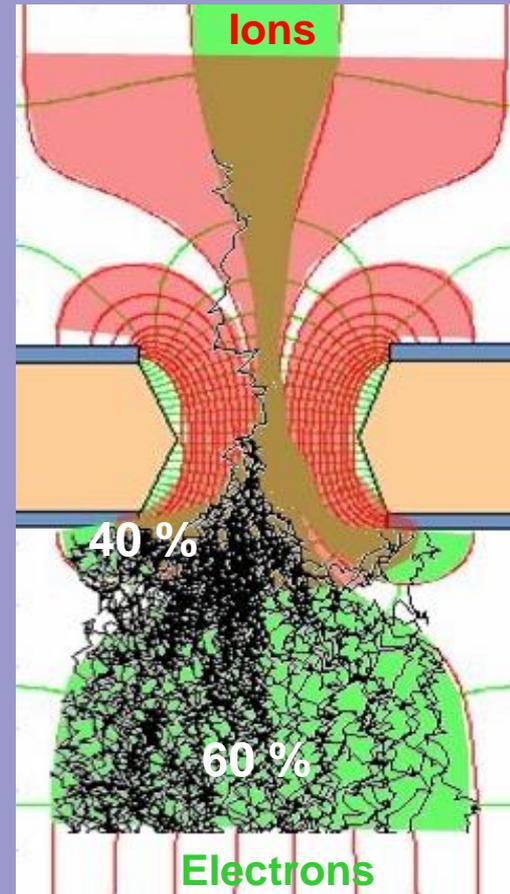
140  $\mu\text{m}$



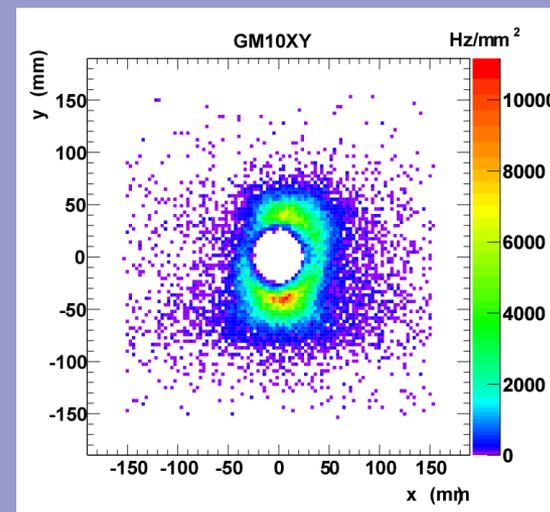
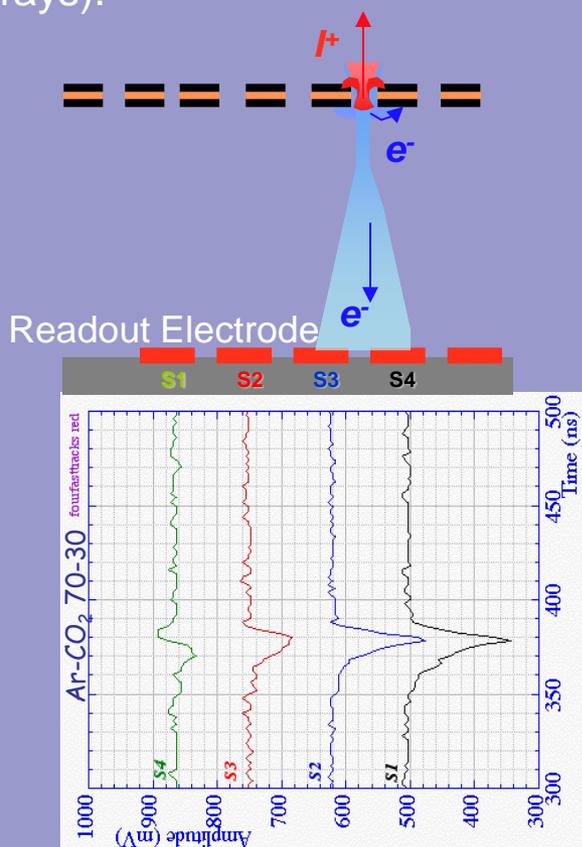
Difference of potentials of  $\sim 500\text{V}$  is applied to each GEM foil. Primary electrons released by radiation, drift towards holes where high electric field triggers electron multiplication process.



55  $\mu\text{m}$   
70  $\mu\text{m}$



Electrons created in the multiplication (avalanche) process in GEM holes are collected on segmented readout electrode. Signal induced on the readout segments allows precise reconstruction of the time and position of the passage of original radiation (charged particles, X-rays).

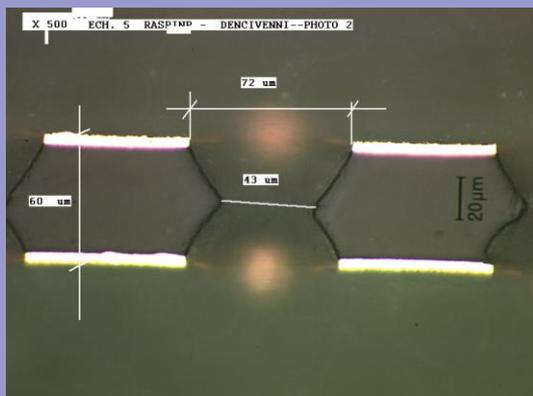


Map of the reconstructed positions of the passage point of charged particles measured at very high intensity beam at CERN in COMPASS experiment.

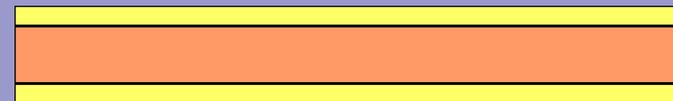
Signals induced on the readout electrode by the electrons created in the avalanche process

# GEM Manufacturing

GEM foils are produced at CERN using proprietary process.



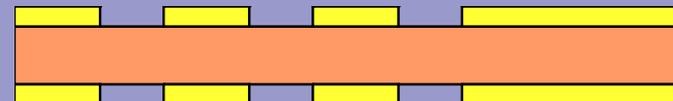
50  $\mu\text{m}$  Kapton  
5  $\mu\text{m}$  Cu both sides



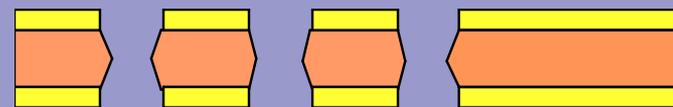
Photoresist coating,  
masking and  
exposure to UV light



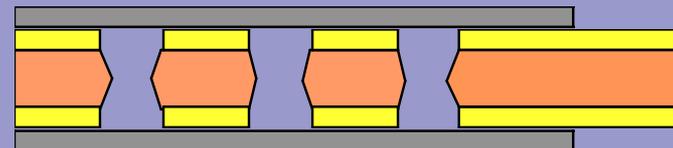
Metal chemical  
etching



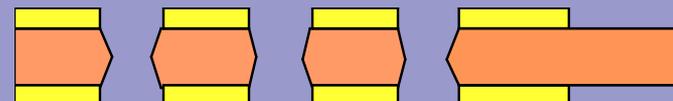
Kapton chemical  
etching

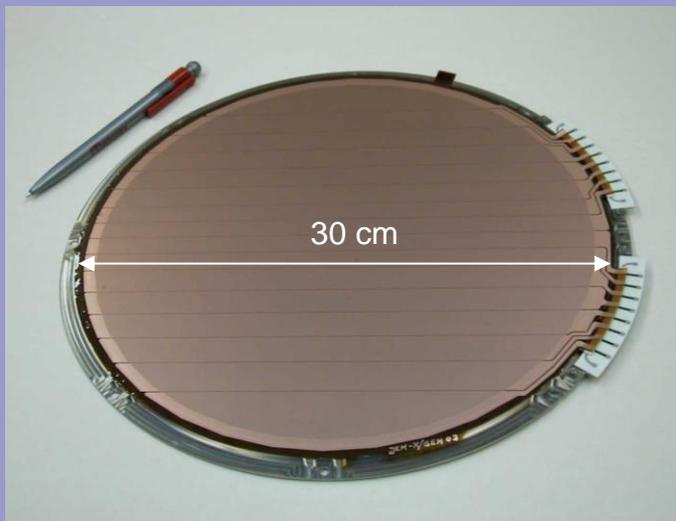
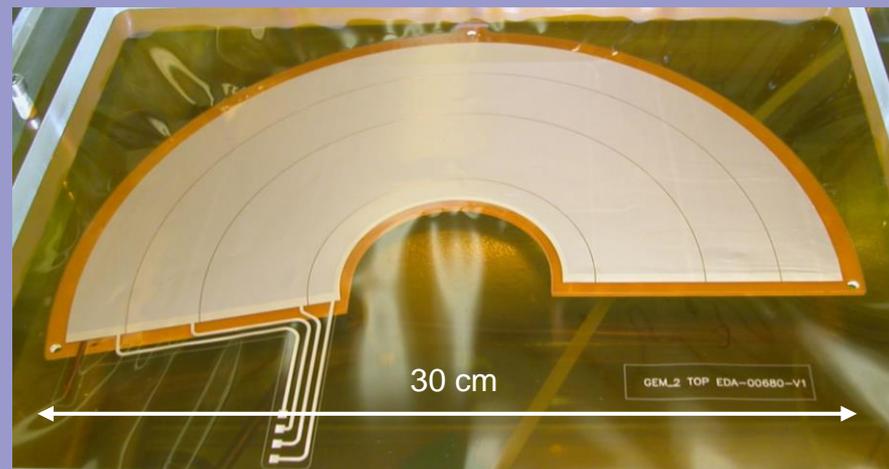
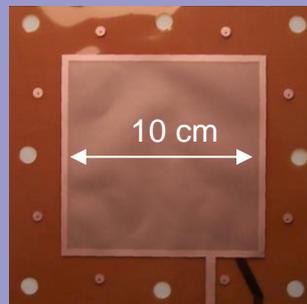
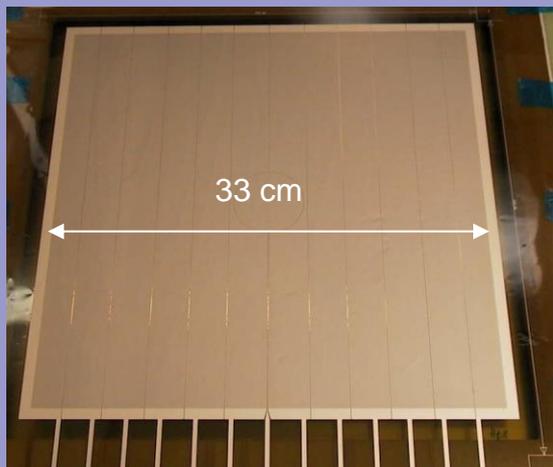


Second masking



Metal etching  
and cleaning





Wide range of shapes and sizes

1500 ÷ 2000 foils manufactured at CERN

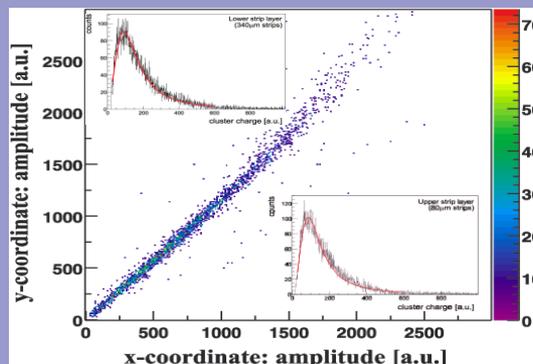
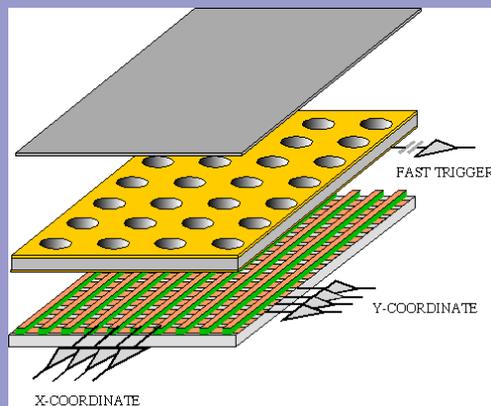
1 cm<sup>2</sup> to 1000 cm<sup>2</sup>

30-200 μm holes, 50-300 μm pitch

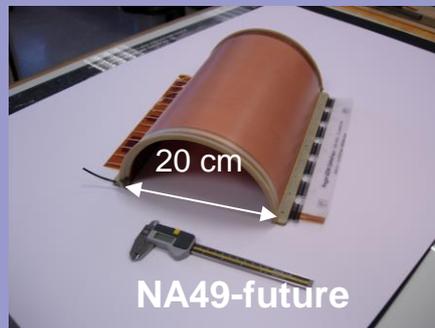
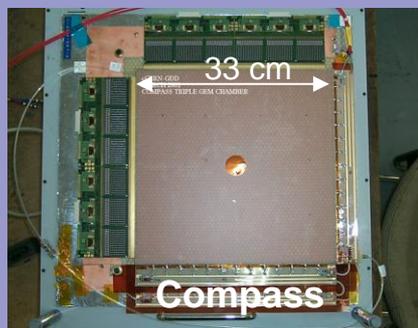
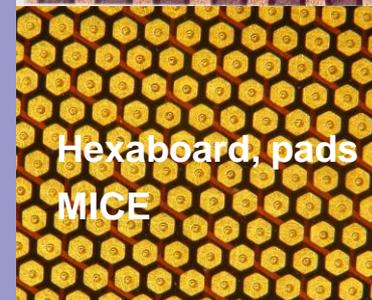
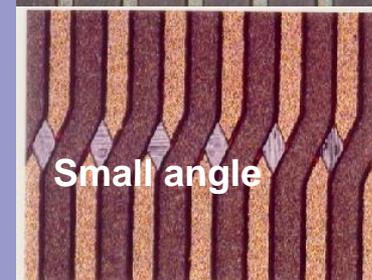


# GEM – Gas Electron Multiplier

Full decoupling of the charge amplification structure from the charge collection and readout structure allows both structures to be optimized independently !



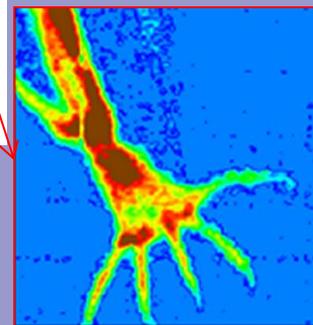
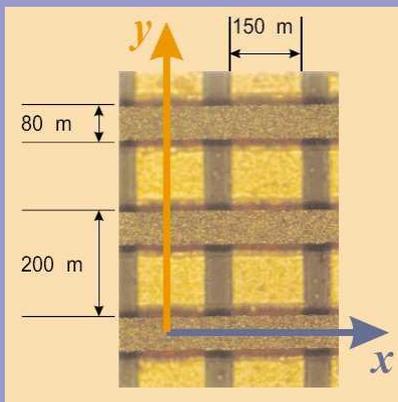
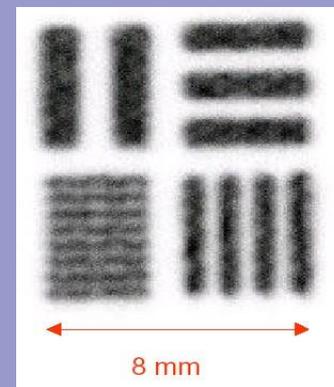
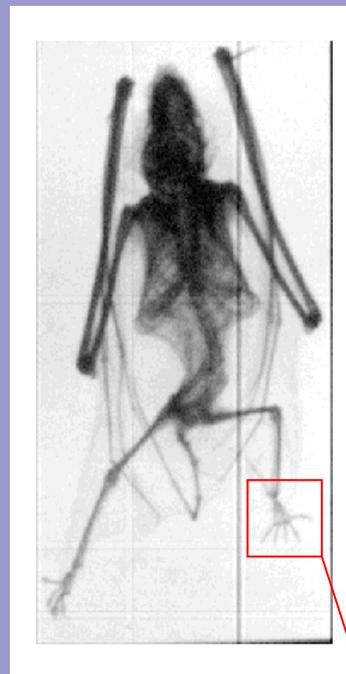
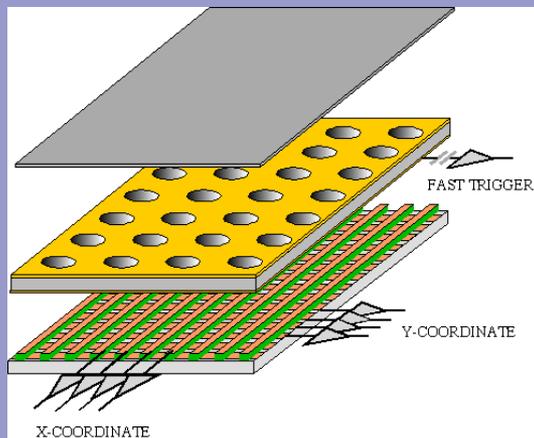
Charge correlation (Cartesian readout)



GEM detectors developed for different CERN experiments.

# Absorption radiography with GEM

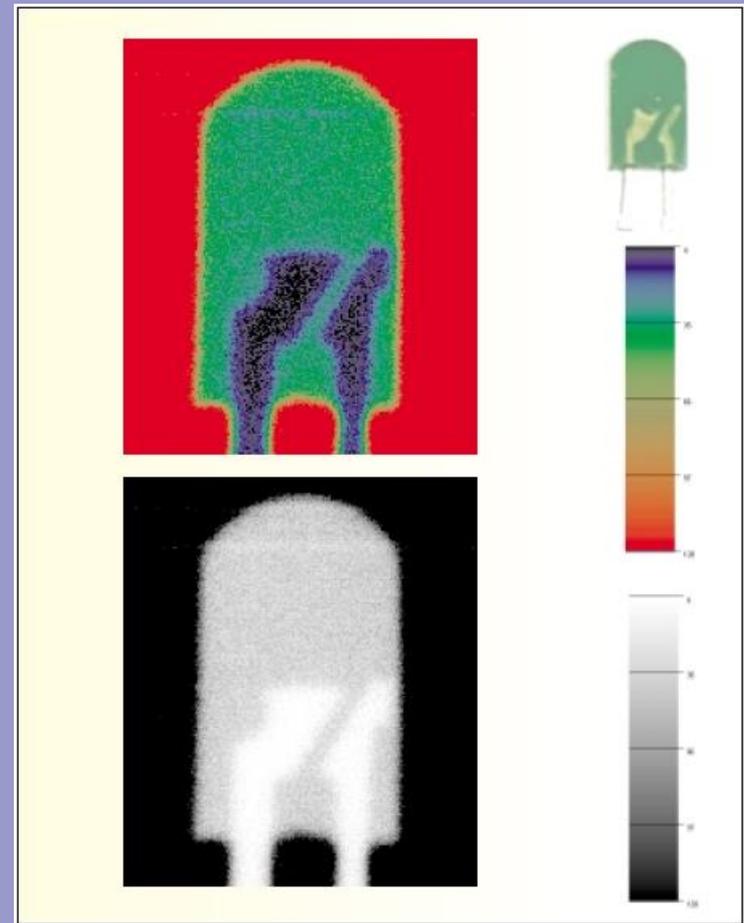
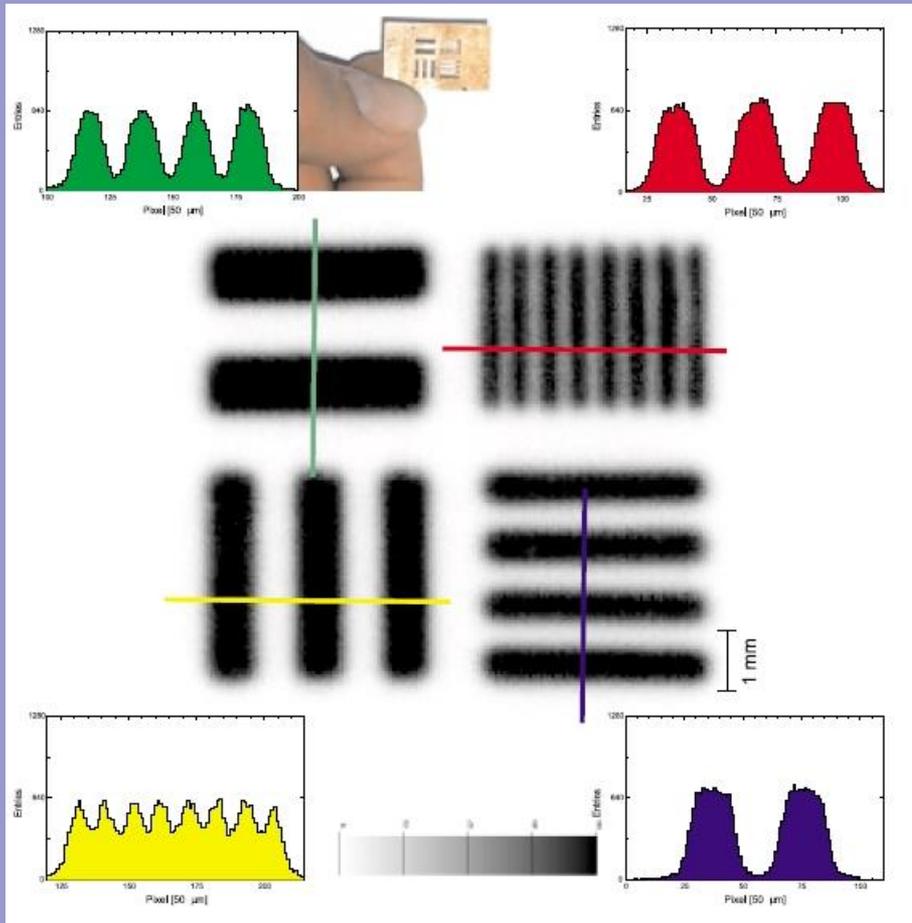
GEM detectors can be used to detect X-Rays !





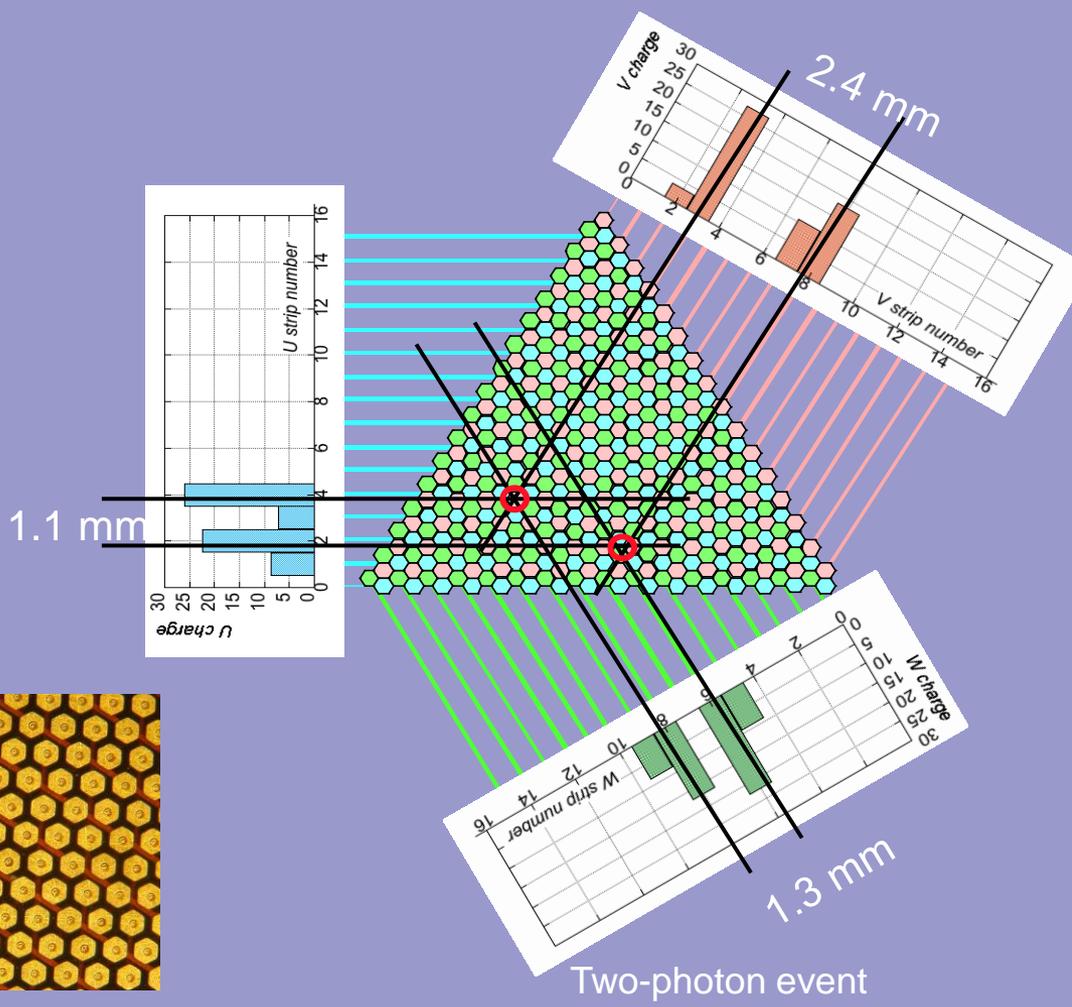
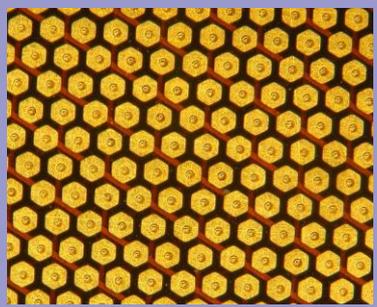
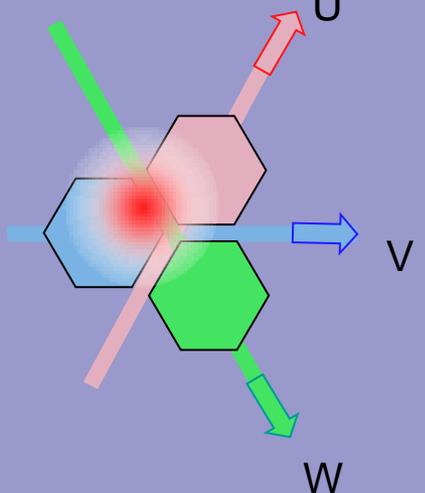
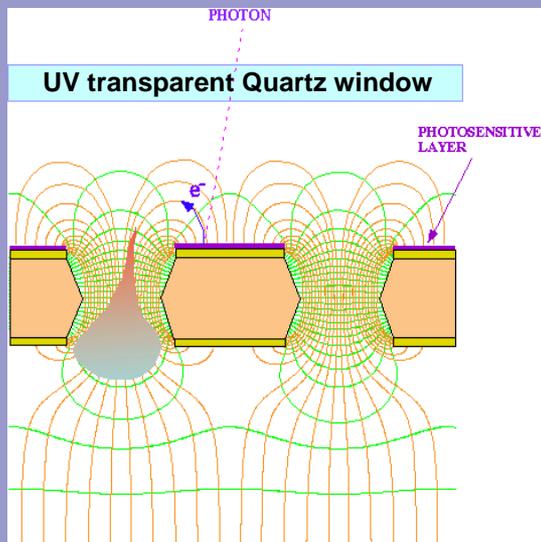
# Absorption radiography with GEM

GEM detectors can be used to detect X-Rays !



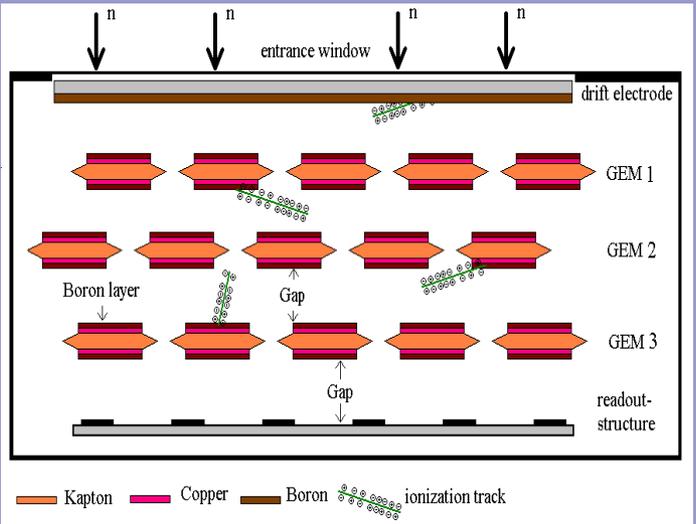
# UV Light Detection

After coating top electrode of upper GEM foil with UV-light sensitive layer, GEM detectors can detect invisible light !



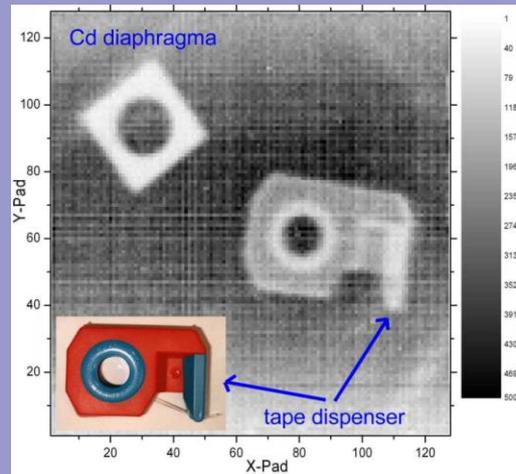
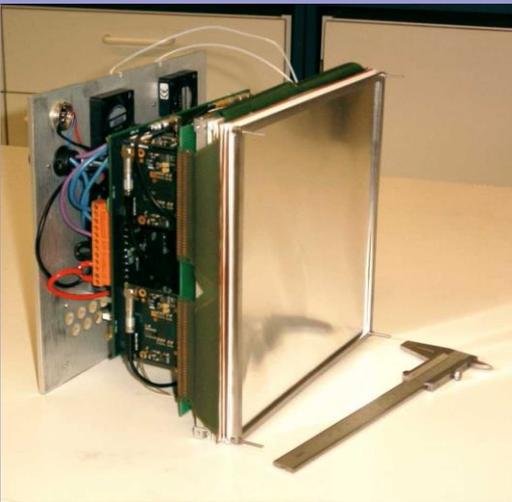


# Detector for Neutron Detection



Coating GEM foils with appropriate converter makes GEM detectors sensitive to neutrons.

## CASCADE Heidelberg

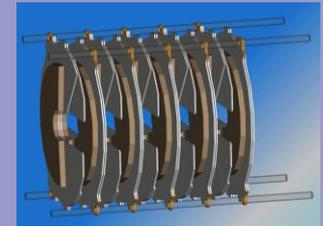
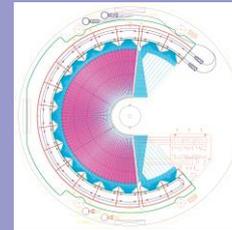
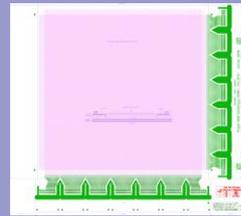




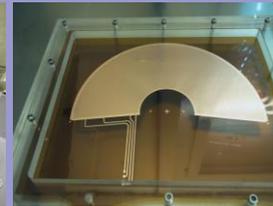
# GEM Detectors at CERN

CERN is involved in all aspects of GEM detectors design, production and applications.

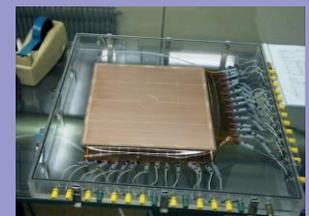
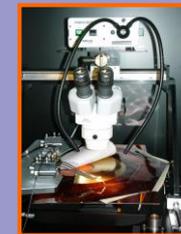
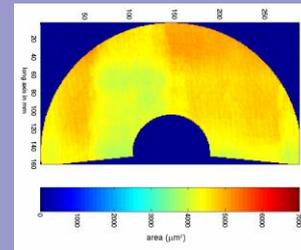
## Detector Design



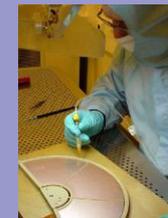
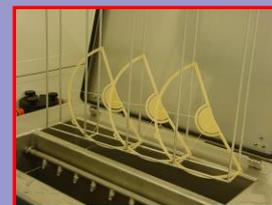
## Component Production



## Component Quality Control



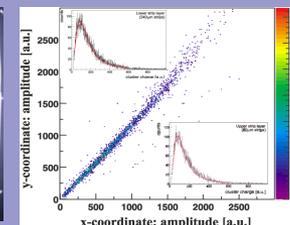
## Detector Assembly



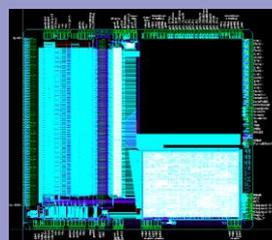


# GEM Detectors at CERN

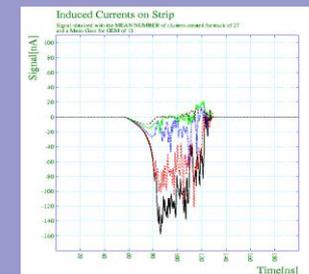
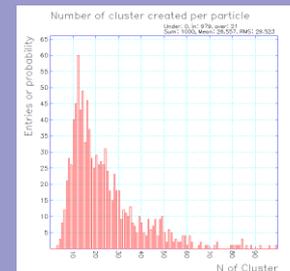
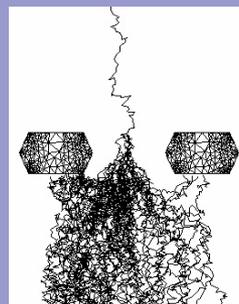
Detector Test



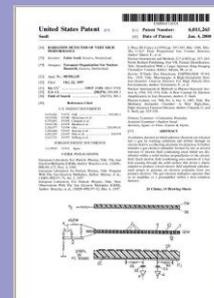
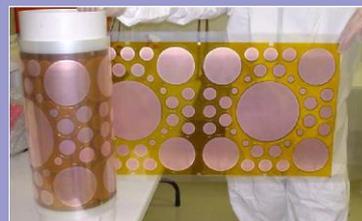
Readout Electronics



Detector Simulations

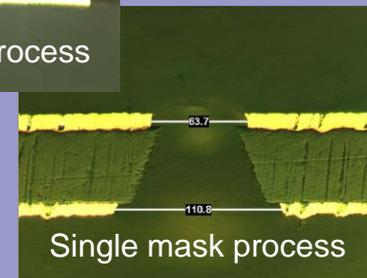
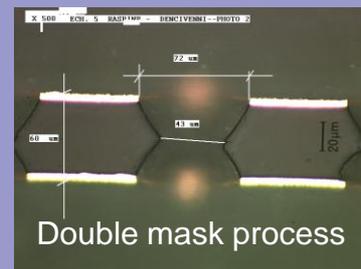
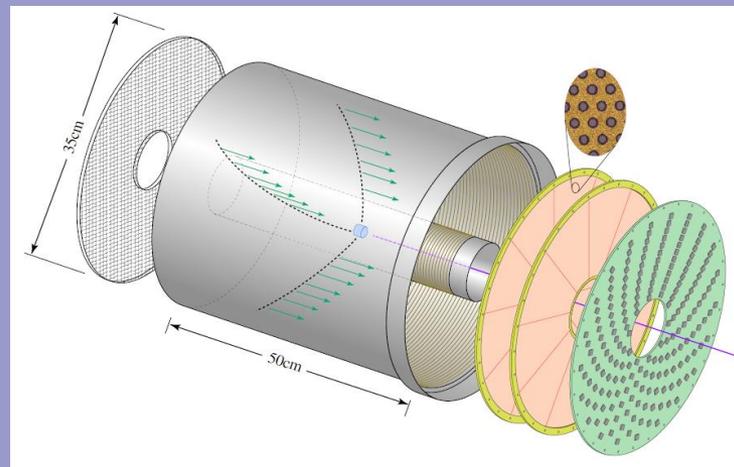
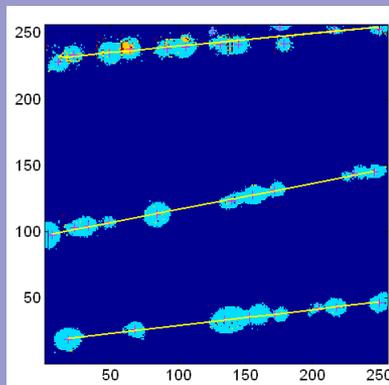


Technology Dissemination



# Perspectives

- Tracking and triggering (LHCb & TOTEM)
- TPC end cap readout
- X-ray radiography
- UV light detection
- Parallax error free detector
- Hadron blind detector
- Neutron detection
- Optical GEM
- Cryogenic detectors
- Two-phase detectors
- High resolution detectors integrated with pixel CMOS chips
- Non planar large acceptance detectors
- Light detectors – mass reduction
- New readout structures adopted to experimental needs
- Large size detectors
- Radiation hardness of assembly materials
- Industrialization of the mass production
- Medical applications



<http://cern.ch/GDD/>